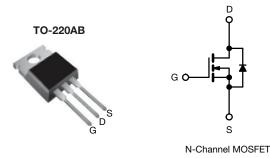
IRF840B



Vishay Siliconix

D Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.85			
Q _g max. (nC)	30				
Q _{gs} (nC)	4				
Q _{gd} (nC)	7				
Configuration	Single				

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Consumer electronics
- Displays (LCD or plasma TV)
- Server and telecom power supplies
- SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF840BPbF
Lead (Pb)-free and halogen-free	IRF840BPbF-BE3

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500		
Gate-source Voltage				± 30	V	
Gate-source voltage AC (f > 1 Hz)			V _{GS}	30		
Continuous drain surrent $(T_{\rm e} = 150 ^{\circ}{\rm C})$	V _{GS} at 10 V T _C	T _C = 25 °C T _C = 100 °C	- I _D -	8.7		
Continuous drain current ($T_J = 150 \ ^\circ C$)		T _C = 100 °C		5.5	A	
Pulsed drain current ^a			I _{DM}	18		
Linear derating factor				1.25	W/°C	
Single pulse avalanche energy ^b			E _{AS}	56	mJ	
Maximum power dissipation			PD	156	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	-source voltage slope $T_J = 125 \text{ °C}$		-IV (/ = I+	24		
Reverse diode dV/dt ^d			dV/dt	0.37	V/ns	
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.
$$V_{DD}$$
 = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 7 Å

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, starting $T_J = 25 \ ^\circ C$

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	0.8	0/W

SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	inless otherw	ise noted)		1	1	1	
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \ \mu\text{A}$		500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	3	-	5	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 100	nA
		V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	<u>,</u>
Zero gate boltage drain current	IDSS	V _{DS} = 400 V	′, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 4 A	-	0.70	0.85	Ω
Forward transconductance ^a	9 _{fs}		= 20 V, I _D = 4 A	-	3	-	S
Dynamic	•			<u> </u>		•	
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	527	-	
Output capacitance	C _{oss}	,	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$		52	-	1
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	8	-	1
Effective output capacitance, energy related ^b	C _{o(er)}			-	46	-	pF
Effective output capacitance, time related ^c	C _{o(tr)}	$V_{DS} = 0 V \text{ to } 400 V, V_{GS} = 0 V$ - 64		-]		
Total gate charge	Qg			-	15	30	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 4 A, V _{DS} = 400 V	-	4	-	nC
Gate-drain charge	Q _{gd}			-	7	-	
Turn-on delay time	t _{d(on)}			-	13	26	
Rise time	t _r	Voo	= 400 V, I _D = 4 A	-	16	32	- ns
Turn-off delay time	t _{d(off)}		9.1 Ω, V _{GS} = 10 V	-	17	34	
Fall time	t _f			-	11	22	
Gate input resistance	R _g	f = 1	MHz, open drain	-	1.8	-	Ω
Drain-Source Body Diode Characteristi			·	•		•	
Continuous source-drain diode current	۱ _S	showing the		8			
Pulsed diode forward current	I _{SM}			-	-	32	- A
Diode forward voltage	V _{SD}	T _J = 25 °	C, I _S = 4 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	308	-	ns
Reverse recovery charge	Q _{rr}		5 °C, $I_F = I_S = 4 A$,	-	1.8	-	μC
Reverse recovery current	I _{BBM}	ai/at =	100 A/µs, V _R = 20 V	-	11	-	A

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

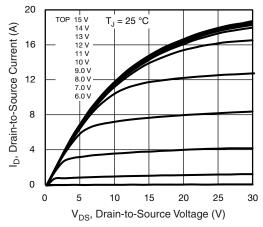


Fig. 1 - Typical Output Characteristics

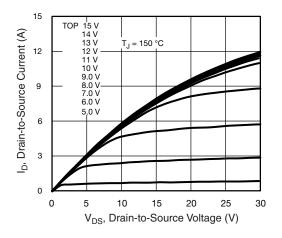
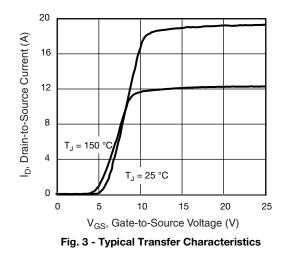


Fig. 2 - Typical Output Characteristics



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3 R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 1 10 V GS 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

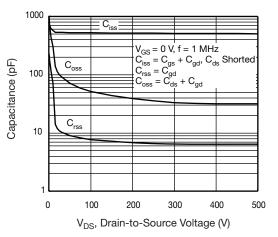
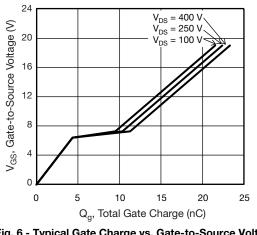


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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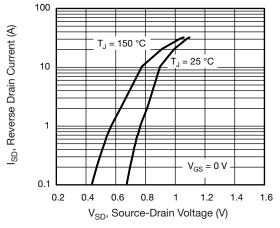
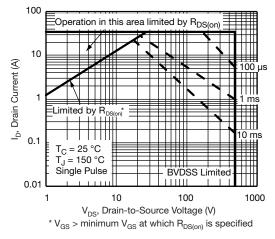
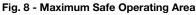


Fig. 7 - Typical Source-Drain Diode Forward Voltage





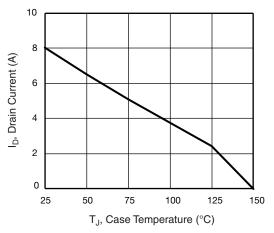


Fig. 9 - Maximum Drain Current vs. Case Temperature

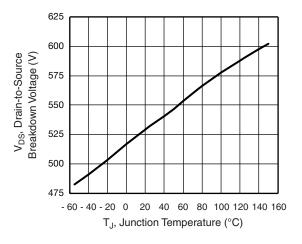
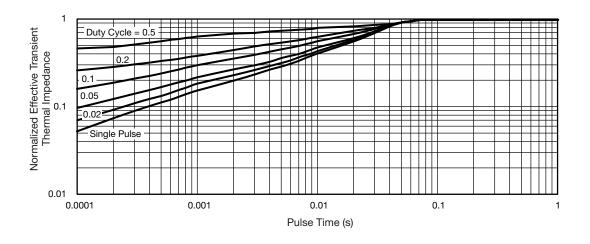


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





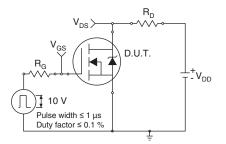
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Fig. 12 - Switching Time Test Circuit

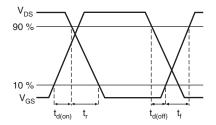


Fig. 13 - Switching Time Waveforms

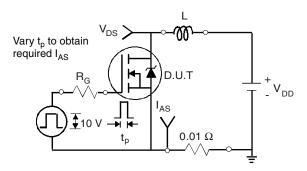


Fig. 14 - Unclamped Inductive Test Circuit

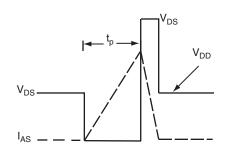


Fig. 15 - Unclamped Inductive Waveforms

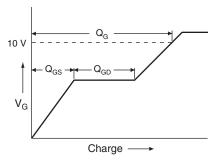


Fig. 16 - Basic Gate Charge Waveform

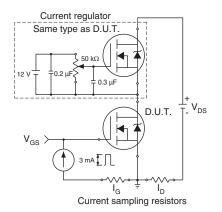
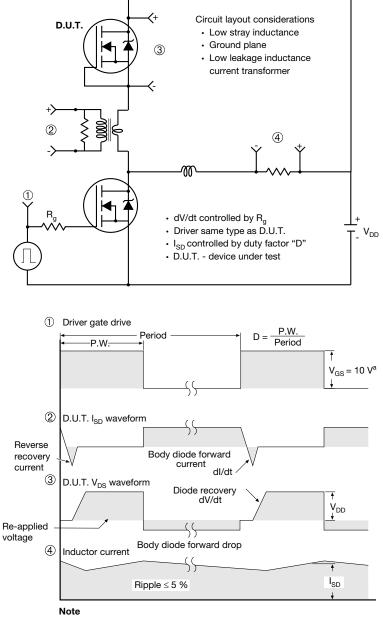


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-220-1



DIM	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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